

STGP35HF60W

35 A, 600 V Ultrafast IGBT

Datasheet - production data

Features

- Improved E_{off} at elevated temperature
- Minimal tail current
- Low conduction losses

Applications

- Welding
- High frequency converters
- Power factor correction

Description

This Ultrafast IGBT is developed using a new planar technology to yield a device with tighter switching energy variation ($E_{\rm off}$) versus temperature. The suffix "W" denotes a subset of products designed for high switching frequency operation (over 100 kHz).

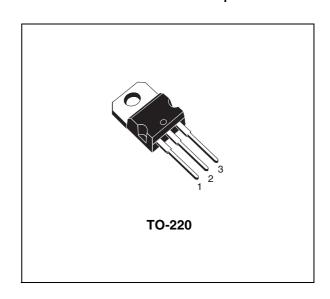


Figure 1. Internal schematic diagram

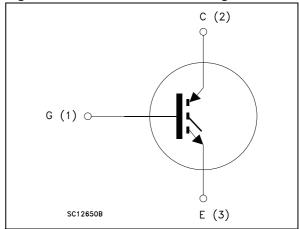


Table 1. Device summary

Order codes	Markings	Packages	Packaging
STGP35HF60W	GP35HF60W	TO-220	Tube

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STGP35HF60W Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	600	V	
I _C ⁽¹⁾	Continuous collector current at T _C = 25 °C	60	Α	
I _C ⁽¹⁾	Continuous collector current at T _C = 100 °C	35	Α	
I _{CP} ⁽²⁾	Pulsed collector current	150	Α	
I _{CL} (3)	Turn-off latching current	80	Α	
V _{GE}	Gate-emitter voltage	± 20	V	
P _{TOT}	Total dissipation at T _C = 25 °C	200	W	
T _{stg}	Storage temperature		°C	
T _j	Operating junction temperature	- 55 to 150		

^{1.} Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2. Pulse width limited by maximum junction temperature and turn-off within RBSOA
- 3. V_{CLAMP} = 80% (V_{CES}), V_{GE} = 15 V, R_{G} = 10 Ω , T_{J} = 150 °C

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case IGBT	0.63	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	62.5	°C/W

Electrical characteristics STGP35HF60W

2 Electrical characteristics

 $T_J = 25$ °C unless otherwise specified)

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	600			V
V	Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 20 A			2.5	V
V _{CE(sat)}		$V_{GE} = 15V, I_{C} = 20 A, T_{J} = 125 °C$		1.65		V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_C = 1 \text{ mA}$	3.75		5.75	٧
loso	Collector cut-off current	V _{CE} = 600 V			250	μΑ
ICES	$(V_{GE} = 0)$	V _{CE} = 600 V, T _J = 125 °C			1	mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ±20 V			± 100	nA

Table 5. Dynamic

	<u> </u>					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$egin{array}{c} C_{ m ies} \ C_{ m res} \end{array}$	Input capacitance Output capacitance Reverse transfer capacitance	$V_{CE} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GE} = 0$	-	2400 235 50	-	pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	$V_{CE} = 400 \text{ V}, I_{C} = 20 \text{ A},$ $V_{GE} = 15 \text{ V},$ (see Figure 16)	-	140 13 52	-	nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 400 V, I_{C} = 20 A R_{G} = 10 Ω , V_{GE} = 15 V, (see Figure 15)	-	30 15 1650	-	ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 400 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_{J} = 125 ^{\circ}\text{C} \text{ (see Figure 15)}$	-	30 15 1600	-	ns ns A/µs
$t_r(V_{off})$ $t_d(_{off})$ t_f	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 400 V, I_{C} = 20 A, R_{GE} = 10 Ω , V_{GE} = 15 V (see Figure 15)	-	30 175 40	-	ns ns ns
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 400 \text{ V}, I_{C} = 20 \text{ A},$ $R_{GE} = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_{J} = 125 \text{ °C}$ (see Figure 15)	-	50 225 70	-	ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E _{on} ⁽¹⁾	Turn-on switching losses	$V_{CC} = 400 \text{ V}, I_{C} = 20 \text{ A}$		290		μJ
E _{off}	Turn-off switching losses	$R_G = 10 \Omega$, $V_{GE} = 15 V$,	-	185		μJ
E_{ts}	Total switching losses	(see Figure 17)		475		μJ
E _{on} ⁽¹⁾	Turn-on switching losses	V _{CC} = 400 V, I _C = 20 A		420		μJ
E _{off}	Turn-off switching losses	$R_G = 10 \Omega$, $V_{GE} = 15 V$,	-	350	530	μJ
E _{ts}	Total switching losses	T _J = 125 °C (see Figure 17)		770		μJ

Eon is the tun-on losses when a typical diode is used in the test circuit in *Figure 17*. If the IGBT is offered
in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs and diode are at the
same temperature (25 °C and 125 °C). Eon include diode recovery energy.

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2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

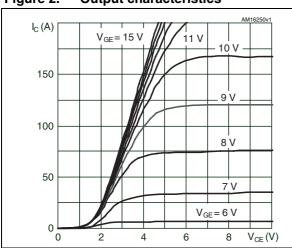


Figure 3. Transfer characteristics

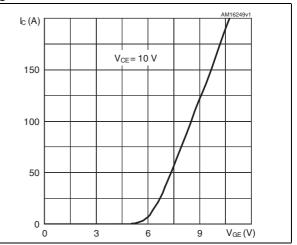


Figure 4. Normalized V_{CE(sat)} vs. I_C

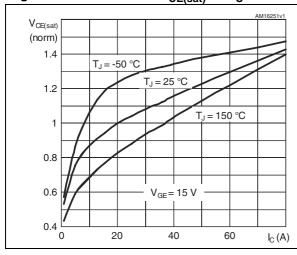


Figure 5. Normalized V_{CE(sat)} vs. temperature

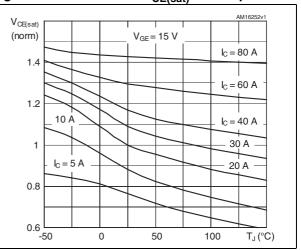
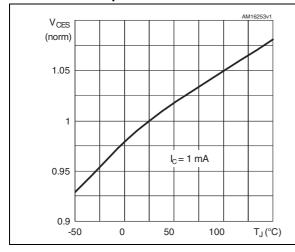


Figure 6. Normalized breakdown voltage vs. Figure 7. Normalized gate threshold voltage temperature vs. temperature



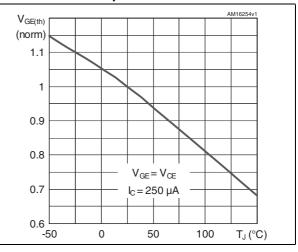
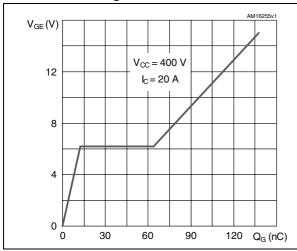


Figure 8. Gate charge vs. gate-emitter voltage

Figure 9. Capacitance variations



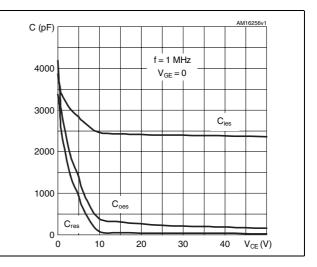
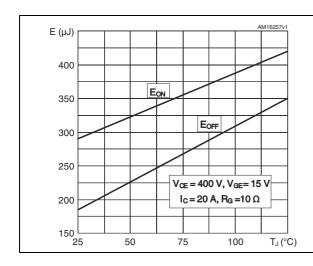


Figure 10. Switching losses vs. temperature

Figure 11. Switching losses vs. gate resistance



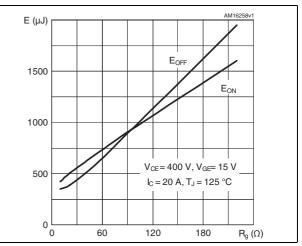
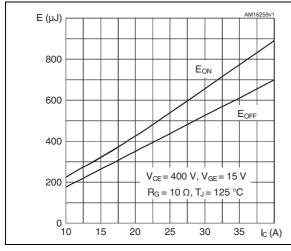
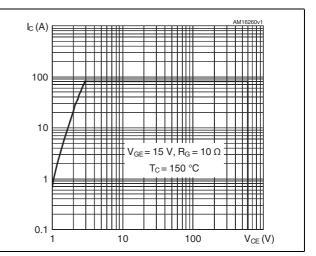


Figure 12. Switching losses vs. collector current

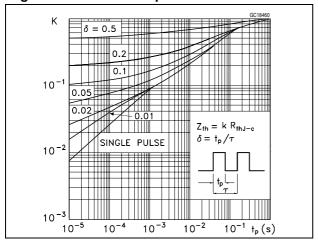
Figure 13. Turn-off SOA





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Figure 14. Thermal impedance



STGP35HF60W Test circuits

3 Test circuits

Figure 15. Test circuit for inductive load switching

Figure 16. Gate charge test circuit

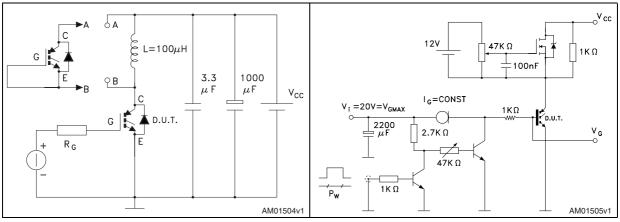
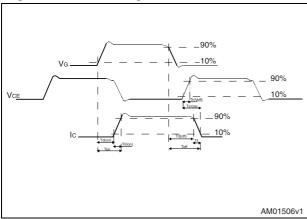


Figure 17. Switching waveform



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

Table 8. TO-220 type A mechanical data

	To 220 type A meonamou	mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
С	0.48		0.70
D	15.25		15.75
D1		1.27	
Е	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95

D D1 L30 D1 L30

Figure 18. TO-220 type A drawing

Revision history STGP35HF60W

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
06-Nov-2012	1	Initial release.

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